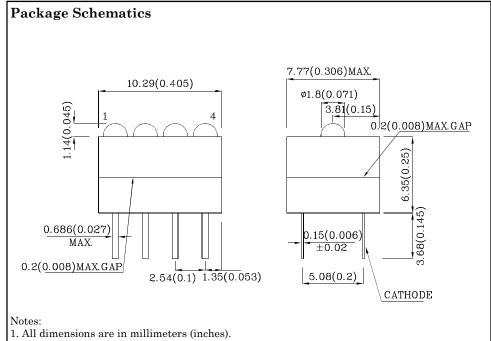




- Housing material: Type 66 Nylon
- Black casing provides superior contrast
- Housing UL rating: 94V-0
- $\bullet$  Reliable & robust
- Custom color combinations available
- 5V internal resistor
- RoHS Compliant







- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings ( $T_A$ =25°C)		UY (GaAsP/GaP)	Unit		
Reverse Voltage	$V_{\mathrm{R}}$	5	V		
Forward Voltage	$V_{\mathrm{F}}$	6	V		
Power Dissipation	$P_D$	85	mW		
Operating Temperature	T <sub>A</sub> -40 ~ +70		°C		
Storage Temperature	Tstg	-40 ~ +85			
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds				
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds				

Operating Characteristics $(T_A=25^{\circ}C)$		UY (GaAsP/GaP)	Unit
Forward Current (Typ.) $(V_F=5V)$	$I_{\mathrm{F}}$	13	mA
Forward Current (Max.) (V <sub>F</sub> =5V)	$I_{\mathrm{F}}$	17.5	mA
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	uA
Wavelength of Peak Emission (Typ.) (V <sub>F</sub> =5V)	λP	590	nm
Wavelength of Dominant Emission (Typ.) (V <sub>F</sub> =5V)	λD	588	nm
Spectral Line Full Width At Half-Maximum (Typ.) (V <sub>F</sub> =5V)	Δλ	35	nm

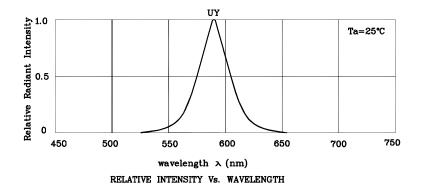
Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous} \\ \text{Intensity} \\ \text{(V}_{\text{F}}\text{=-}5\text{V}) \\ \text{mcd} \end{array}$		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
XNG4ZUY46D5V	Yellow	GaAsP/GaP	Yellow Diffused	1.2	4.8	590	40°
Apr 13,2011					XDSA27	40 V6 Layout:	Maggie L.

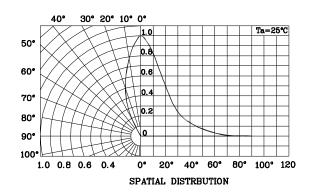




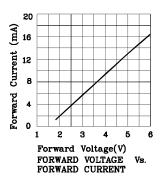


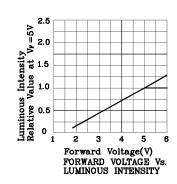


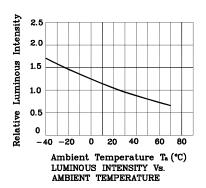




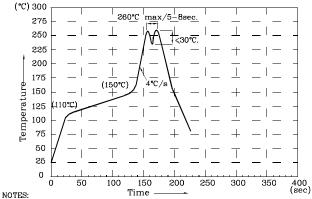
## UY







Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



- I.Becommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.

  2.Do not apply stress on epoxy resins when temperature is over 85°C.

  3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering, the PCB top-surface temperature should be kept below 105°C.
- 5.No more than once

## Remarks:

If special sorting is required (e.g. binning based on Luminous intensity/ luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity/ luminous flux: +/-15%

Note: Accuracy may depend on the sorting parameters.





## PACKING & LABEL SPECIFICATIONS

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